

an extruding section which extrudes a fluidizing resin into the opening of the mask;

a first drive section which drives the extruding section;

a first control section which has positional information on a position of the opening of the mask and which causes the extruding section to be driven by controlling the first drive section based on the positional information;

a squeegee which causes a movement of the fluidizing resin present over the opening which is extruded from the extruding section into the opening;

a second drive section which drives the squeegee; and

a second control section which has the positional information on the position of the opening of the mask and which causes the squeegee to be driven by controlling the second drive section based on the positional information.

*B1*

8. (Amended) A resin encapsulating apparatus for forming a protection resin sealing body on a semiconductor device in which the resin sealing body and external connection balls are formed on the same surface side of the semiconductor device, the resin encapsulating apparatus comprising:

*B2*

a retaining section which retains the semiconductor device;

a mask set on the semiconductor device and having an opening at which, when the mask is set on the semiconductor device, an area of the semiconductor device at which the resin sealing body is to be formed is exposed;

an extruding section which extrudes a fluidizing resin into the opening of the mask;

FINNEGAN  
HENDERSON  
FARABOW  
GARRETT &  
DUNNER LLP

1300 I Street, NW  
Washington, DC 20005  
202.408.4000  
Fax 202.408.4400  
www.finnegan.com

*B2*

a first drive section which drives the extruding section;  
a first control section which has positional information on a position of the opening of the mask and which causes the extruding section to be driven by controlling the first drive section based on the positional information;  
a squeegee which causes a movement of the fluidizing resin present over the opening which is extruded from the extruding section into the opening;  
a second drive section which drives the squeegee; and  
a second control section which has the positional information on the position of the opening of the mask and which causes the squeegee to be driven by the controlling the second drive section based on the positional information.

--21. (New) A resin encapsulating apparatus according to claim 1, wherein the second drive section drives the squeegee independently of the first drive section which drives the extruding section.

*B3*  
*Sub J17*

22. (New) A resin encapsulating apparatus according to claim 21, wherein the squeegee moves separately from the extruding section.

23. (New) A resin encapsulating apparatus according to claim 21, wherein the second drive section causes the squeegee to come into contact with one side of the opening of the mask, to move to another side of the opening which is opposed to the one side of the opening, and then to move away from the mask.

FINNEGAN  
HENDERSON  
FARABOW  
GARRETT &  
DUNNER LLP

1300 I Street, NW  
Washington, DC 20005  
202.408.4000  
Fax 202.408.4400  
[www.finnegan.com](http://www.finnegan.com)